



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

■ Z21

These assemblies are ESD sensitive, ESD precautions shall be observed.

■ Z22

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

■ Z23

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9772	REV: A	SUN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Top Assembly Drawing	GENERATED : 6/26/2015 5:20:02 PM	TEXAS INSTRUMENTS	

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